

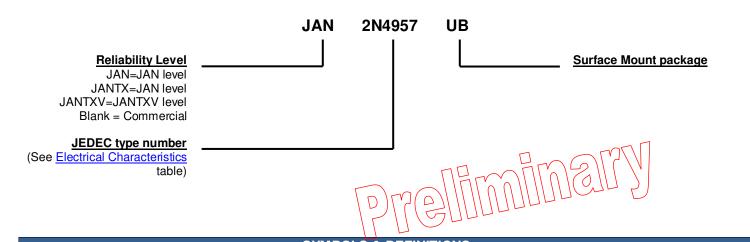




MECHANICAL and PACKAGING

- CASE: Ceramic
- TERMINALS: Gold plating over nickel underplate
- MARKING: Part number, date code, manufacturer's ID
- POLARITY: PNP, see case outline on last page
- TAPE & REEL option: Standard per EIA-418D. Consult factory for quantities
- WEIGHT: < 0.04 grams
- See <u>Package Dimensions</u> on last page.

PART NOMENCLATURE



SYMBOLS & DEFINITIONS						
Symbol	Definition					
Ι _Β	Base current: The value of the dc current into the base terminal.					
Ι _C	Collector current: The value of the dc current into the collector terminal.					
Ι _Ε	Emitter current: The value of the dc current into the emitter terminal.					
T _A	Ambient temperature: The air temperature measured below a device, in an environment of substantially uniform temperature, cooled only by natural air convection and not materially affected by reflective and radiant surfaces.					
Tc	Case temperature: The temperature measured at a specified location on the case of a device.					
V _{CB}	Collector-base voltage: The dc voltage between the collector and the base.					
V _{CBO}	Collector-base voltage, base open: The voltage between the collector and base terminals when the emitter terminal is open-circuited.					
V _{CEO}	Collector-emitter voltage, base open: The voltage between the collector and the emitter terminals when the base terminal is open-circuited.					
V _{EB}	Emitter-base voltage: The dc voltage between the emitter and the base.					
V _{EBO}	Emitter-base voltage, collector open: The voltage between the emitter and base terminals with the collector terminal open-circuited.					



ELECTRICAL CHARACTERISTICS @ T_c = +25°C

OFF CHARACTERISTICS

Test Conditions	Symbol	Va		
Test conditions	Symbol	Min.	Max.	Unit
Collector-Emitter Breakdown Voltage $I_{C} = -1.0 \text{ mA}, I_{B} = 0$, Bias condition D	$V_{(BR)CEO}$	-30	-	V
Collector to Base Cutoff Current $V_{CB} = -20 \text{ V}, I_E = 0$, Bias condition D $V_{CB} = -30 \text{ V}$, Bias condition D	I _{CBO}	-	-100 -100	nA μA
Emitter to Base Cutoff Current V _{EB} = -3 V, Bias condition D	I _{EBO}	-	-100	μA

ON CHARACTERISTICS

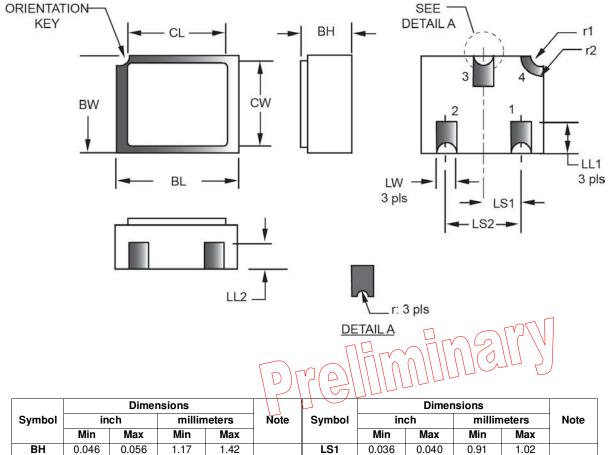
Test Conditions	Cumhal	Va		
Test Conditions	Symbol	Min.	Max.	Unit
Forward Current transfer ratio				
I _C = -0.5 mA, V _{CE} = -10 V		15 20 30	165	
$I_{C} = -2.0 \text{ mA}, V_{CE} = -10 \text{ V}$	h _{FE}			
I _C = -5.0 mA, V _{CE} = -10 V	UFE			
I _C = -5.0 mA, V _{CE} = -10 V, T _A = -55 ^o C		10	_	

DYNAMIC CHARACTERISTICS

DYNAMIC CHARACTERISTICS								
Test Conditions	Symbol	Min.	lue Max.	Unit				
Magnitude of common emitter small signal short circuit forward current transfer ratio $V_{CE} = -10 \text{ V}$, $I_E = -2.0 \text{ mA}$, f = 100 MHz	h _{fe}	12	36					
Collector-base time constant $I_E = -2.0 \text{ mA}, V_{CB} = -10.0 \text{ V}, f = 63.6 \text{ MHz}$	r _b 'C _c	1.0	8.0	ps				
Collector to Base – feedback capacitance I_E = 0 mA, V _{CB} = -10 V, 100 kHz \leq f \leq 1 MHz	C _{cb}		0.8	pF				
Noise Figure (50 Ohms) I_{C} = -2.0 mA, V_{CE} = -10 V, f = 450 MHz, R_{L} = 50 Ω	NF		3.5	dB				
Small Signal Power Gain (common emitter) I_{C} = -2.0 mA, V _{CE} = -10 V, f = 450 MHz	G _{pe}	17	25	dB				



PACKAGE DIMENSIONS



	win	Max	win	iviax		win	Max	win	Max	
BH	0.046	0.056	1.17	1.42	LS1	0.036	0.040	0.91	1.02	
BL	0.115	0.128	2.92	3.25	LS2	0.071	0.079	1.80	2.01	
BW	0.085	0.108	2.16	2.74	LW	0.16	0.24	0.41	0.61	
CL	-	0.128	-	3.25	r	-	0.008	-	0.20	
CW	-	0.108	-	2.74	r1	-	0.012	-	0.31	
LL1	0.022	0.038	0.56	0.97	r2	-	0.022	-	0.056	
LL2	0.017	0.035	0.43	0.89						

NOTES:

- 1. Dimensions are in inches.
- Millimeters are given for information only.
 Hatched areas on package denote metallized areas.
- 4. Pad 1 = Base, Pad 2 = Emitter, Pad 3 = Collector, Pad 4 = Shielding connected to the lid.
- 5. In accordance with ASME Y14.5M, diameters are equivalent to Φx symbology.